

TRANSISTOR

MOS-FET

IGBT

DIODE

SEMICONDUCTOR DYNAMIC CHARACTERISTIC EVALUATION SYSTEM 半導体動特性評価システム

SWRL1510ZZ 1500V
1000A

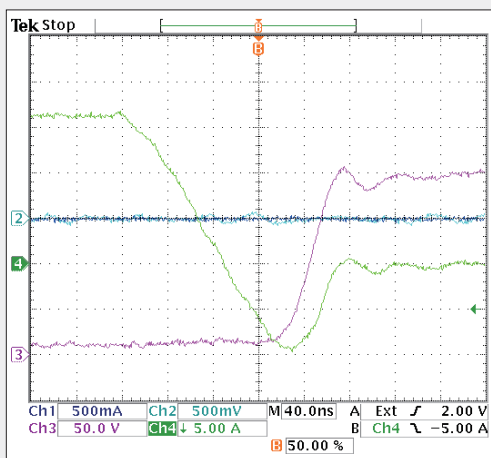
NEW



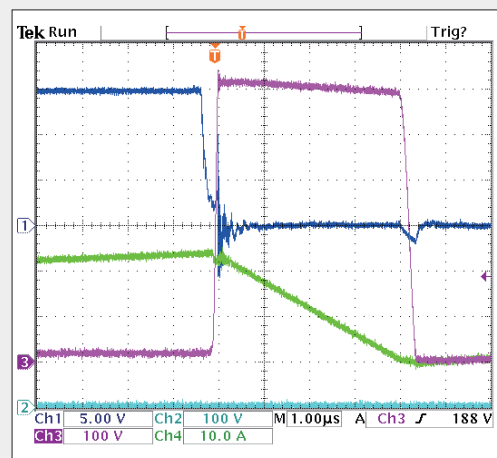
● SWRL1510ZZ has 1ms forcing function at 1500V, 1000A, which is enough power for power device dynamic characteristics tester. Measurement part is designed for testing in both low and high temperature. It can connect to external chamber to evaluate device by temperature characteristics.

● 1500V, 1000Aで1msの印加性能を持っており、パワーデバイスの動特性試験として十分なパワーを備えています。測定部はデバイスを冷却または高温状態で測定できるような構造が考慮されており、外部チャンバーとの接続を可能とし、温度特性によるデバイス評価を可能としています。

Measurement Waveform (di/dt)



Measurement Waveform (Avalanche)



MODEL	SWRL1510ZZ	
TEST ITEMS		
R-SWITCHING/L-SWITCHING	td(on), tr, td(off), tf, e(on), e(off), e(sw)	
AVALANCHE	VSUS, EAS, EAP, IDP	
di/dt	di/dt, IRP, trr, Qrr	
QG	QGs, QGd, QG	
SETTING RANGE		
MEASURABLE DEVICE	Transistor, MOS-FET, IGBT, Diode	
MEASUREMENT RANGE	000ns~999μs	
VDD	10V~1500V	1V STEP
ID (Limit)	10A~1000A	10A STEP
VGF	0.0V~30.0V	0.1V STEP [Maximum pulse current 10A] [最大パルス電流10A]
VGR	0.0V~30.0V	0.1V STEP [Maximum pulse current 10A] [最大パルス電流10A]
Rg	0.0Ω~99.9Ω	0.1Ω STEP
IBF/IBR	0.01A~3.00A	0.01A STEP
V-CLAMP	30V~1500V	1V STEP
Time-1	0.1μs~999.9μs	0.1μs STEP
Time-2	0.1μs~999.9μs	0.1μs STEP
Time-3	0.1μs~99.9μs	0.1μs STEP
IG	0.1mA~99.9mA	0.1mV STEP
VG-CLAMP	1V~25V	1V STEP
X-bias	0.01V~15.00V	0.01V STEP
IM	1mA~200mA	1mA STEP
Vf	1mV~200mV	1mV STEP
BINNING		
OPEN /SHORT CHECK	VGF ON : VDS(VCE) > VDD × 50% ... OPEN VGF OFF : VDS(VCE) < VDD × 50% ... SHORT	
BIN INDICATION	PASS, LIMIT-FAIL/CONTACT-FAIL, ERROR/DRIVE-FAIL, OPEN/SHORT	
DIMENSIONS & WEIGHT		
SUPPLY UNIT	550(W) × 870(D) × 1700(H) ... 395kg	
CONTROL UNIT	1200(W) × 550(D) × 1280(H) ... 235kg	
MEASUREMENT UNIT	1200(W) × 650(D) × 840(H) ... 300kg	